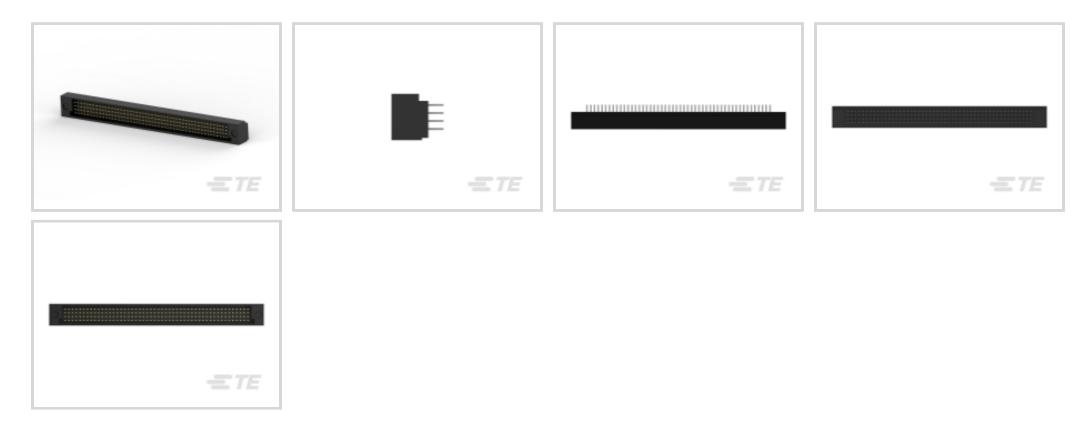
532436-7 - ACTIVE

AMP-HDI

TE Internal #: 532436-7 PCB Mount Header, Vertical, Board-to-Board, 200 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 200

Number of Rows: 4

Features

Connectivity

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	200
Number of Rows	4
Electrical Characteristics	
Insulation Resistance	4 MΩ
Body Features	
Primary Product Color	Black

PCB Mount Header, Vertical, Board-to-Board, 200 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



Contact Features

Contact Layout	Matrix
	.21 in
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Four Beam
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.83 mm[.19 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention Type	Retention Solder Tails

Operation/Application	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Housing Temperature Rating	High
Usage Conditions	
PCB Thickness (Recommended)	1.57 mm[.76 in]
Connector Height	11.73 mm[.462 in]
Dimensions	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Housing Features	
Connector Mounting Type	Board Mount
PCB Mount Alignment	Without
PCB Mount Retention	Without
Mating Alignment Type	Keyed
Mating Alignment	Without

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PCB Mount Header, Vertical, Board-to-Board, 200 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	4
Packaging Type	Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements:

Halogen Content

Solder Process Capability

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Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Not lead free process capable

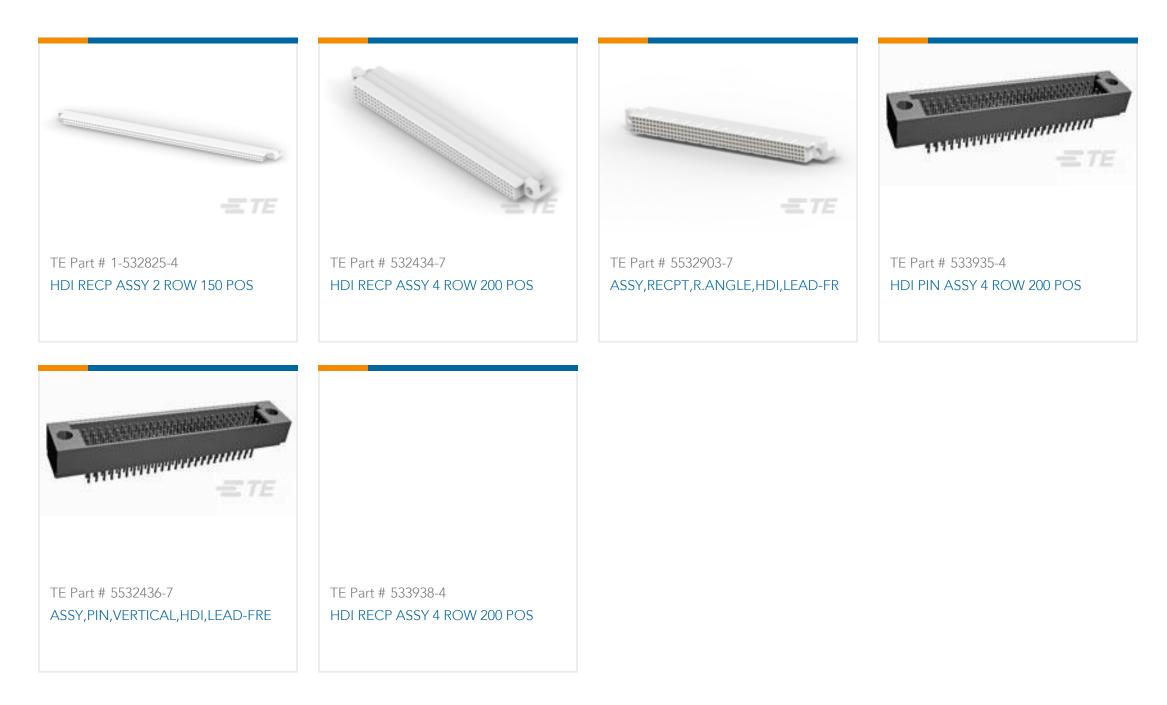
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

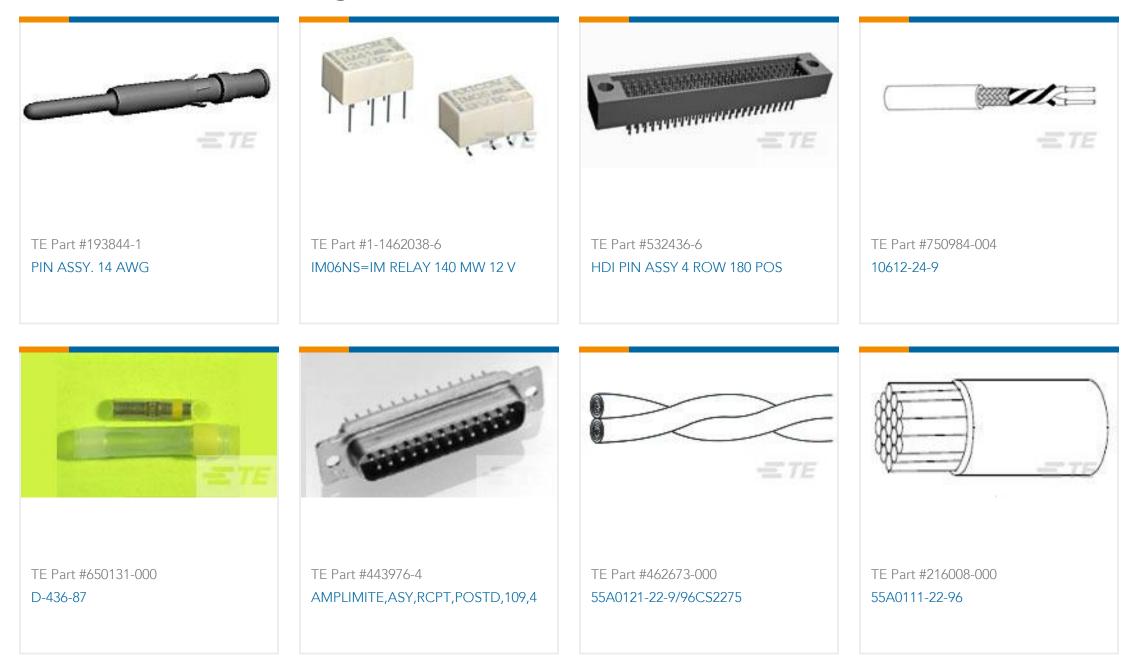
Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 200 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black





Customers Also Bought



TE Part #CA3613-000 CEC-RWC-18664

Documents

PCB Mount Header, Vertical, Board-to-Board, 200 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



Product Drawings HDI PIN ASSY 4 ROW 200 POS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_532436-7_T.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_532436-7_T.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_532436-7_T.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English

Instruction Sheets Instruction Sheet (U.S.)

English

Agency Approvals Agency Approval Document

English